SN75LVDM976
SN75LVDM977

## 9-CHANNEL DUAL-MODE TRANSCEIVERS

## FEATURES

- 9 Channels for the Data and Control Paths of the Small Computer Systems Interface (SCSI)
- Supports Single-Ended and Low-Voltage Differential (LVD) SCSI
- CMOS Input Levels ('LVDM976) or TTL Input Levels ('LVDM977) Available
- Includes DIFFSENS Comparators on CDEO
- Single-Ended Receivers Include Noise Pulse Rejection Circuitry
- Packaged in Thin Shrink Small-Outline Package With 20-Mil Terminal Pitch
- Low Disabled Supply Current 7 mA Maximum
- Power-Up/Down Glitch Protection
- Bus is High-Impedance With $\mathrm{V}_{\mathrm{Cc}}=1.5 \mathrm{~V}$
- Pin-Compatible With the SN75976ADGG

High-Voltage Differential Transceiver

## DESCRIPTION

The SN75LVDM976 and SN75LVDM977 have nine transceivers for transmitting or receiving the signals to or from a SCSI data bus. They offer electrical compatibility to both the single-ended signaling of X3.277:1996-SCSI-3 Parallel Interface (Fast-20) and the new low-voltage differential signaling method of proposed standard 1142-D SCSI Parallel Interface 2 (SPI-2).
The differential drivers are nonsymmetrical. The SCSI bus uses a dc bias on the line to allow terminated fail safe and wired-OR signaling. This bias can be as high as 125 mV and induces a difference in the high-to-low and low-to-high transition times of a symmetrical driver. In order to reduce pulse skew, an LVD SCSI driver's output characteristics become nonsymmetrical. In other words, there is more assertion current than negation current to or from the driver. This allows the actual differential signal voltage on the bus to be symmetrical about 0 V . Even though the driver output characteristics are nonsymmetrical, the design of the 'LVDM976 drivers maintains balanced signaling. Balanced means that the current that flows in each signal line is nearly equal but opposite in direction and is one of the keys to the low-noise performance of a differential bus.


## AVAILABLE OPTIONS

| $\mathbf{T}_{\mathbf{A}}$ | PACKAGE |  |
| :---: | :---: | :---: |
|  | TSSOP (DGG) <br> CMOS INPUT LEVELS | TSSOP (DGG) <br> TTL INPUTS <br> LEVELS |
|  |  |  |
| $70^{\circ} \mathrm{C}$ |  |  | | SN75LVDM976DGG |
| :---: |
| SN75LVDM976DGGR |${ }^{(1)} .$| SN75LVDM977DGG |
| :---: |
| SN75LVDM977DGGR |

(1) The $R$ suffix designates a taped and reeled package.

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## DESCRIPTION (CONTINUED)

The signal symmetry requirements of the LVD-SCSI bus mean you can no longer obtain logical inversion of a signal by simply reversing the differential signal connections. This requires the ability to invert the logic convention through the INV/NON terminal. This input would be a low for SCSI controllers with active-high data and high for active-low data. In either case, the B+ signals of the transceiver must be connected to the SIGNAL+ line of the SCSI bus and the B- of the transceiver to the SIGNAL- line.
The CDEO input incorporates a window comparator to detect the status of the DIFFSENS line of a SCSI bus. This line is below 0.5 V , if using single-ended signals, between 1.7 V and 1.9 V if low-voltage differential, and between 2.4 V and 5.5 V if high-voltage differential. The outputs assume the characteristics of single-ended or LVD accordingly or place the outputs into high-impedance, when HVD is detected. This, and the INV/NON input, are the only differences to the trade-standard function of the SN75976A HVD transceiver.
Two options are offered to minimize the signal noise margins on the interface between the communications controller and the transceiver. The SN75LVDM976 has logic input voltage thresholds of about $0.5 \mathrm{~V}_{\mathrm{CC}}$. The SN75LVDM977 has a fixed logic input voltage threshold of about 1.5 V . The input voltage threshold should be selected to be near the middle of the output voltage swing of the corresponding driver circuit.
The SN75LVDM976 and SN75LVDM977 are characterized for operation over an free-air temperature range of $T_{A}$ $=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

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## LOGIC DIAGRAM (POSITIVE LOGIC)



## LOGIC DIAGRAMS AND FUNCTION TABLES



Figure 1. Inverting LVD Transceiver


Figure 2. Inverting Single-Ended Transceiver


Figure 3. Inverting Single-Ended Driver


Figure 4. Inverting LVD Driver

FUNCTION TABLE

| INPUTS |  |  | OUTPUTS |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $(\mathrm{B}+-\mathrm{B}-)$ | $\mathrm{DE} / \overline{\mathrm{RE}}$ | A | $\mathrm{B}+$ | $\mathrm{B}-$ | A |
| $\mathrm{V}_{\mathrm{ID}} \geq 30 \mathrm{mV}$ | L | NA | Z | Z | L |
| $-30 \mathrm{mV}<\mathrm{V}_{\mathrm{ID}}<30$ <br> mV | L | NA | Z | Z | $?$ |
| $\mathrm{~V}_{\mathrm{ID}}-30 \mathrm{mV}$ | L | NA | Z | Z | H |
| Open circuit | L | NA | Z | Z | $?$ |
| NA | H | L | H | L | Z |
| NA | H | H | L | H | Z |

FUNCTION TABLE

| INPUTS |  |  | OUTPUTS |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| B- | DE/RE | A | B+ | B- | A |
| H | L | NA | L | Z | L |
| L | L | NA | L | Z | H |
| Open circuit | L | NA | L | Z | $?$ |
| NA | H | L | L | H | Z |
| NA | H | H | L | L | Z |

FUNCTION TABLE

| INPUT | OUTPUTS |  |
| :---: | :---: | :---: |
| A | B+ | B- |
| L | L | H |
| $H$ | L | L |

FUNCTION TABLE

| INPUT | OUTPUTS |  |
| :---: | :---: | :---: |
| A | B+ | B- |
| L | $H$ | L |
| $H$ | L | $H$ |

FUNCTION TABLE

| INPUT | OUTPUTS |  |
| :---: | :---: | :---: |
| A | B+ | B- |
| L | L | H |
| $H$ | $H$ | L |

FUNCTION TABLE

| INPUTS |  |  | OUTPUTS |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $(\mathrm{B}+-\mathrm{B}-)$ | $\mathrm{DE} / \mathrm{RE}$ | A | $\mathrm{B}+$ | $\mathrm{B}-$ | A |
| $\mathrm{V}_{\mathrm{ID}} \geq 30 \mathrm{mV}$ | L | NA | Z | Z | H |
| $-30 \mathrm{mV}<\mathrm{V}_{\mathrm{ID}}<30$ <br> mV | L | NA | Z | Z | $?$ |
| $\mathrm{~V}_{\text {ID }} \leq-30 \mathrm{mV}$ | L | NA | Z | Z | L |
| Open circuit | L | NA | Z | Z | $?$ |
| NA | H | L | L | H | Z |
| NA | H | H | H | L | Z |

FUNCTION TABLE

| INPUTS |  |  | OUTPUTS |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| B- | DE/RE | A | B+ | B- | A |
| H | L | NA | L | Z | H |
| L | L | NA | L | Z | L |
| Open circuit | L | NA | L | Z | $?$ |
| NA | H | L | L | L | Z |
| NA | H | H | L | H | Z |

FUNCTION TABLE

| INPUT | OUTPUTS |  |
| :---: | :---: | :---: |
| A | B+ | B- |
| L | L | L |
| $H$ | L | H |



Control Inputs

| CDE0 | $0.7 \mathrm{~V}<\mathrm{V}_{\mathrm{l}}<1.9 \mathrm{~V}$ |
| ---: | :---: |
| INV/ $\overline{\mathrm{NON}}$ | L |
| CDE1 | L |
| CDE2 | L |

(a)










Control Inputs

| CDE0 | $0.7 \mathrm{~V}<\mathrm{V}_{\mathrm{I}}<1.9 \mathrm{~V}$ |
| ---: | :---: |
| INV/NON | L |
| CDE1 | L |
| CDE2 | H |

(b)






Control Inputs

(c)

Figure 9. Logic Diagrams










Control Inputs

| CDE0 | $0.7 \mathrm{~V}<\mathrm{V}_{\text {I }}<1.9 \mathrm{~V}$ |
| ---: | :---: |
| INV/NON | L |
| CDE1 | H |
| CDE2 | H |

(a)





5DE/RE





Control Inputs

| CDE0 | $0.7 \mathrm{~V}<\mathrm{V}_{\mathrm{I}}<1.9 \mathrm{~V}$ |
| ---: | :---: |
| INV/NON | H |
| CDE1 | L |
| CDE2 | L |

(b)








Control Inputs CDEO $\quad 0.7 \mathrm{~V}<\mathrm{V}_{1}<1.9 \mathrm{~V}$ INV/NON CDE1 CDE2
(C)

Figure 10. Logic Diagrams

Figure 11. Logic Diagrams










Control Inputs

| CDE0 | $0.7 \mathrm{~V}<\mathrm{V}_{\mathrm{I}}<1.9 \mathrm{~V}$ |
| ---: | :---: |
| INV/NON | H |
| CDE1 | H |
| CDE2 | H |

(a)

(b)


(c)





3 SO







| Control Inputs |  |
| ---: | :---: |
| CDE0 | $\mathrm{V}_{\mathrm{l}}<0.5 \mathrm{~V}$ |
| INV/NON | L |
| CDE1 | H |
| CDE2 | L |

(a)

2A 2B-

3B-









(b)

Figure 12. Logic Diagrams
(c)

$$
\begin{array}{cc}
\text { CDEO } & \mathrm{V}_{\mathbf{l}}<0.5 \mathrm{~V} \\
\text { INV/NON } & \mathrm{H} \\
\text { CDE1 } & \mathrm{L} \\
\text { CDE2 } & \mathrm{L}
\end{array}
$$


(a)










Control Inputs

(b)

Figure 13. Logic Diagrams


2 S

3 S

4A

5 S





(c)


| Control Inputs |  |
| :---: | :---: |
| CDE0 | $\mathrm{V}_{1}>2.5 \mathrm{~V}$ |
| INV/NON | X |
| CDE1 | X |
| CDE2 | X |

Figure 14. Logic Diagrams

INPUT AND OUTPUT EQUIVALENT SCHEMATIC DIAGRAMS


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## Terminal Functions

| TERMINAL |  | 'LVDM976 Logic Level | 'LVDM977 Logic | I/O | Terminat ion | DESCRIPTION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| NAME | NO. |  |  |  |  |  |
| 1A-9A | $\begin{aligned} & 4,6,8,10 \\ & 19,21,23 \\ & 25,27 \end{aligned}$ | CMOS | TTL | I/O | Pullup | 1A-9A carry data to and from the communication controller. |
| 1B-9B- | $\begin{aligned} & 29,31,33 \\ & 35,37,46 \\ & 48,50,52 \end{aligned}$ | LVD or TTL | LVD or TTL | I/O | None | 1B- to 9B- are the signals to and from the data bus. When INV/NON is low, the logic sense is the opposite that of the A input (inverted). When $I N V / \overline{N O N}$ is high, the logic sense is the same as the A input (noninverted). |
| $1 \mathrm{~B}+-9 \mathrm{~B}+$ | $\begin{aligned} & 30,32,34, \\ & 36,38,47 \\ & 49,51,53 \end{aligned}$ | LVD or GND | LVD or GND | I/O | None | When in the LVD mode, 1B+-9B+ are signals to or from the data bus and follow the same logic sense as the $A$ input when INV/NON is low (noninverted). The logic sense is opposite that of the A input (inverted) when INV/NON is high. When in single-ended mode, these terminals become a ground connection through a transistor and do not switch. |
| CDEO | 54 | Trinary | Trinary | Input | None | CDEO is the common driver enable 0 . With the driver enabled and the CDE0 input less than 0.5 V , the driver output is single-ended mode. With the driver enabled and the CDE0 input between 0.7 V and 1.9 V the driver output is LVD mode. All drivers are disabled when the input is greater than 2.4 V . |
| CDE1 | 55 | CMOS | TTL | Input | Pulldown | CDE1 is the common driver enable 1 . When CDE1 is high, drivers 1-4 are enabled |
| CDE2 | 56 | CMOS | TTL | Input | Pulldown | CDE2 is the common driver enable 2. When CDE2 is high, drivers 5 to 8 are enabled. |
| $\begin{aligned} & \text { 1DE/RE - } \\ & \text { 9DE/RE } \end{aligned}$ | $\begin{aligned} & 5,7,9,11 \\ & 20,22,24 \\ & 26,28 \end{aligned}$ | CMOS | TTL | Input | Pulldown | 1DE/ $\overline{\mathrm{RE}}-9 \mathrm{DE} / \overline{\mathrm{RE}}$ are direction controls that transmit data to the bus when it is high and CDEO is below 2.2 V . Data is received from the bus when 1DE/RE-9DE/RE, CDE1, and CDE2 are low. |
| GND | $\begin{aligned} & 2,3,13,14 \\ & 15,16,17 \\ & 40,41,42 \\ & 43,44 \end{aligned}$ | NA | NA | Power | NA | GND is the circuit ground. |
| INV/NON | 1 | CMOS | CMOS | Input | Pullup | A high-level input to INV/ $\overline{N O N}$ inverts the logic to and from the A terminals. (i.e., the voltage at A terminal and the corresponding Bterminal are in phase.) |
| $\mathrm{V}_{\mathrm{CC}}$ | $\begin{aligned} & 12,18,39 \\ & 45 \end{aligned}$ | NA | NA | Power | NA | Supply voltage |

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) ${ }^{(1)}$

| $\mathrm{V}_{\mathrm{CC}}$ |  | Supply voltage range ${ }^{(2)}$ |  |
| :--- | :--- | :--- | :---: |
| $\mathrm{V}_{\mathrm{I}}$ | Input voltage range | $(\mathrm{A}, \mathrm{INV} / \overline{\mathrm{NON}})$ | UNIT |
|  | (DE/RE, B+, B-, CDE0, CDE1, CDE2) | -0.5 V to 7 V |  |
| Continuous total power dissipation |  |  | -0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ |
| $\mathrm{~T}_{\text {stg }}$ | Storage temperature range, | See Dissipation Rating Table |  |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds |  |  |  |

[^0]
## DISSIPATION RATING TABLE

| PACKAGE | $\mathrm{T}_{\mathrm{A}} \leq 25^{\circ} \mathrm{C}$ <br> POWER RATING | DERATING FACTOR <br> ABOVE $\mathrm{T}_{\mathrm{A}}=\mathbf{2 5} \mathbf{5}^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ <br> POWER RATING |
| :---: | :---: | :---: | :---: |
| DGG | 978 mW | $10.8 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | 492 mW |

## RECOMMENDED OPERATING CONDITIONS (see Figure 15)

|  |  |  | MIN | NOM MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 4.75 | $5 \quad 5.25$ | V |
|  | ge | SN75LVDM976 | $0.7 \mathrm{~V}_{\mathrm{CC}}$ |  | V |
| $V_{\text {IH }}$ | High-level input volage | SN75LVDM977 | 2 |  | V |
|  |  | SN75LVDM976 |  | $0.3 \mathrm{~V}_{\text {CC }}$ | V |
|  | Low-level input voltage | SN75LVDM977 |  | 0.8 |  |
| $\left\|\mathrm{V}_{\text {ID }}\right\|$ | Differential input voltage | Differential receiver | 0.03 | 3.6 | V |
| $\mathrm{V}_{\text {IC }}$ | Common-mode input volta |  | 0.7 | 1.8 | V |
| $\mathrm{V}_{\mathrm{OD} \text { (bias) }}$ | Differential output voltage bias | Differential | 100 | 125 | mV |
|  | High-level output curr | Single-ended driver |  | 7 |  |
|  | -level output current | Receiver |  | 2 | mA |
|  | Low-level output current | Single-ended driver |  | 48 | mA |
|  | Low-level output current | Receiver |  | 2 | mA |
| $\mathrm{Z}_{\mathrm{L}}$ | Differential load impedanc |  | 40 | 65 | $\Omega$ |
| $\mathrm{T}_{\text {A }}$ | Operating free-air tempera |  | 0 | 70 | ${ }^{\circ} \mathrm{C}$ |

## ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | MIN TYP ${ }^{(1)}$ MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{H}}$ | High-level input current | CDE1 and CDE2 |  | 50 | $\mu \mathrm{A}$ |
|  |  | INV/NON |  | 50 |  |
|  | Low-level input current | CDE1 and CDE2 |  | 50 | $\mu \mathrm{A}$ |
|  |  | INV/NON |  | 50 |  |
|  | Supply current |  | Disabled | 7 | mA |
|  |  |  | LVD drivers enabled, No load | 26 |  |
|  |  |  | Single-ended drivers enabled, No load | 10 |  |
|  |  |  | LVD receivers enabled, No load | 26 |  |
|  |  |  | Singled-ended receivers enabled, No load | 7 |  |
|  | Input capacitance | Bus terminal | $\mathrm{V}_{1}=0.2 \sin (2 \pi(1 \mathrm{E} 06) \mathrm{t})+0.5 \pm 0.01 \mathrm{~V}$ | 9.5 | pF |
| $\Delta \mathrm{C}_{\mid}$Difference in input capacitance between $\mathrm{B}+$ and $\mathrm{B}-$ |  |  |  | 0.2 |  |

(1) All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

## DIFFSENS (CDE0) RECEIVER ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP( | MAX | UNIT |
| :--- | :--- | :--- | ---: | ---: | ---: |
|  |  |  | 0.5 | 0.6 | 0.7 |
| $\mathrm{~V}_{\text {IT1 }}$ | Input threshold voltage |  | 1.9 | 2.1 | 2.4 |
| $\mathrm{~V}_{\text {IT2 }}$ | Input threshold voltage |  |  |  |  |
| $\mathrm{I}_{1}$ | Input current | $0 \mathrm{~V} \leq \mathrm{V}_{1} \leq 2.7 \mathrm{~V}$ | $\pm 1$ | $\mu \mathrm{~A}$ |  |
| $\mathrm{I}_{\text {(OFF) }}$ | Power-off input current | $\mathrm{V}_{\mathrm{CC}}=0,0 \mathrm{~V} \leq \mathrm{V}_{1} \leq 2.7 \mathrm{~V}$ |  |  |  |

(1) All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

## LVD DRIVER ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP(1) | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OD}(\mathrm{H})}$ | Driver differential high-level output voltage |  | $\begin{aligned} & \mathrm{V}_{(1)}=0.96 \mathrm{~V}, \mathrm{~V}_{1(2)}=0.53 \mathrm{~V}, \\ & \text { See Figure } 16 \end{aligned}$ | 270 | 460 | 780 | mV |
|  |  |  | $0.69\left\|\mathrm{~V}_{\mathrm{OD}(L)}\right\|+50$ |  | $1.45\left\|\mathrm{~V}_{\mathrm{OD}(\mathrm{L})}\right\|-65$ |  |
|  |  |  | $\begin{aligned} & \mathrm{V}_{(1)=1}=1.96 \mathrm{~V}, \mathrm{~V}_{1(2)}=1.53 \mathrm{~V}, \\ & \text { See Figure } 16 \end{aligned}$ | 270 | 500 | 780 |  |
|  |  |  | $0.69\left\|\mathrm{~V}_{\mathrm{OD}(\mathrm{L})}\right\|+50$ |  | $1.45\left\|\mathrm{~V}_{\mathrm{OD}(\mathrm{L})}\right\|-65$ |  |
| $\mathrm{V}_{\mathrm{OD}(\mathrm{L})}$ | Driver differential low-level output voltage |  |  | $\begin{aligned} & \mathrm{V}_{1(1)}=0.96 \mathrm{~V}, \mathrm{~V}_{1(2)}=0.53 \mathrm{~V}, \\ & \text { See Figure 16 } \end{aligned}$ | 260 | 400 | 640 | mV |
|  |  |  | $\begin{aligned} & \mathrm{V}_{1(1)}=1.96 \mathrm{~V}, \mathrm{~V}_{1(2)}=1.53 \mathrm{~V}, \\ & \text { See Figure 16 } \end{aligned}$ | 260 | 400 | 640 |  |  |
| $\mathrm{V}_{\mathrm{OC}(\mathrm{SS})}$ | Steady-state common-mode output voltage |  | $\begin{aligned} & \mathrm{V}_{(1)}=1.41 \mathrm{~V}, \mathrm{~V}_{1(2)}=0.99 \mathrm{~V}, \\ & \text { See Figure 17 } \end{aligned}$ | 1.1 | 1.2 | 1.5 | V |  |
| $\Delta \mathrm{V}_{\mathrm{OC}(\mathrm{SS})}$ | Change in steady-state common-mode output voltage between logic states |  |  |  | $\pm 50$ | $\pm 120$ | mV |  |
| $\mathrm{V}_{\mathrm{OC}(\mathrm{PP})}$ | Peak-to-peak common-mode output voltage |  |  |  | 80 | 150 | mV |  |
| ${ }_{1} \mathrm{H}$ | High-level input current | A | $\mathrm{V}_{\mathrm{IH}}=3.3 \mathrm{~V}\left({ }^{\prime} 976\right) \mathrm{V}_{\mathrm{IH}}=2 \mathrm{~V}\left({ }^{(977)}\right.$ | 7 |  |  | $\mu \mathrm{A}$ |  |
|  |  | DE/RE |  |  |  | 50 |  |  |
| $\mathrm{I}_{1 /}$ | Low-level input current | A | $\mathrm{V}_{\text {IL }}=1.6 \mathrm{~V}\left({ }^{\prime} 976\right) \mathrm{V}_{\text {IL }}=0.8 \mathrm{~V}\left({ }^{\prime} 977\right)$ |  |  | 30 | $\mu \mathrm{A}$ |  |
|  |  | DE/RE |  | 8 |  |  |  |  |
| $\mathrm{l}_{\text {O(OFF) }}$ | Power-off output current |  | $\mathrm{V}_{\mathrm{CC}}=0,0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq 2.5 \mathrm{~V}$ |  |  | $\pm 1$ | $\mu \mathrm{A}$ |  |
| $\mathrm{l}_{0 S}$ | Short-circuit output current |  | $0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq 2.5 \mathrm{~V}$ |  |  | $\pm 24$ | mA |  |
| $\mathrm{l}_{0 z}$ | High-impedance output current |  | $\mathrm{V}_{\mathrm{O}}=0$ or 2.5 V |  |  | $\pm 1$ | $\mu \mathrm{A}$ |  |

(1) All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

## LVD DRIVER SWITCHING CHARACTERISTICS

over recommended operating conditions (unless otherwise noted) (See Figure 16)

|  | PARAMETER | TEST CONDITIONS |  | MIN | $\begin{array}{r} \text { TYP( } \\ \text { 1) } \end{array}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {PLH }}$ | Propagation delay time, low-to-high level output | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V} \\ & \mathrm{~V}_{12}=0.99 \mathrm{~V}, \end{aligned}$ |  | 2.9 |  | 8.8 | ns |
| $\mathrm{t}_{\text {PHL }}$ | Propagation delay time, high-to-low level output |  |  | 2.9 |  | 8.8 | ns |
| $\mathrm{t}_{\mathrm{r}}$ | Differential output signal rise time |  |  | 1 | 3 | 6 | ns |
| $t_{f}$ | Differential output signal fall time |  |  | 1 | 3 | 6 | ns |
| $\mathrm{t}_{\text {sk(p) }}$ | Pulse skew ( $\left\|\mathrm{t}_{\text {PHL }}-\mathrm{t}_{\text {PLH }}\right\|$ ) |  |  |  |  | 3.7 | ns |
| $\mathrm{t}_{\text {sk(lim) }}$ | Skew limit ${ }^{(2)}$ |  |  |  |  | 5.9 | ns |
| $\mathrm{t}_{\mathrm{PHZ}}$ | Propagation delay time, high-level to high-impedance output | $\begin{aligned} & \mathrm{V}_{11}=1.41 \mathrm{~V}, \\ & \text { See Figure } 18 \end{aligned} \quad \mathrm{~V}_{12}=0.99 \mathrm{~V},$ |  |  |  | 50 | ns |
| $\mathrm{t}_{\text {en }}$ | Enable time, receiver to driver |  |  |  |  | 33 | ns |

(1) All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(2) $t_{\text {sk(lim) }}$ is the maximum delay time difference between any two drivers on any two devices operating at the same supply voltage and the same ambient temperature. SN75LVDM977

## SINGLE-ENDED DRIVER ELECTRICAL CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS |  | MIN | TYP MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | B- output | $\mathrm{I}_{\mathrm{OH}}=-7 \mathrm{~mA}$, | See Figure 19 | 2 | 3.24 | V |
|  |  |  | $\mathrm{l}_{\mathrm{OH}}=0 \mathrm{~mA}$ |  |  | 3.7 | V |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage | B- output | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$, | $\mathrm{I}_{\mathrm{OL}}=48 \mathrm{~mA}$ |  | 0.5 | V |
|  |  | B+ | $\mathrm{l}_{\mathrm{OL}}=-25 \mathrm{~mA}$ |  |  | -0.5 | V |
|  |  |  | $\mathrm{I}_{\mathrm{OL}}=25 \mathrm{~mA}$ |  |  | 0.5 |  |
| $\mathrm{I}_{\mathrm{H}}$ | High-level input current | A | $\mathrm{V}_{\mathrm{IH}}=3.3 \mathrm{~V}$ ('976), $\mathrm{V}_{\mathrm{IH}}=2 \mathrm{~V}\left({ }^{\prime} 977\right)$ |  | -7 |  | $\mu \mathrm{A}$ |
|  |  | DE/RE |  |  |  | 50 |  |
| 1 IL | Low-level input current | A | $\mathrm{V}_{\mathrm{IL}}=1.6 \mathrm{~V}(' 976)$, | $\mathrm{V}_{\mathrm{IL}}=0.8 \mathrm{~V}$ ('977) |  | -30 | $\mu \mathrm{A}$ |
|  |  | DE/RE |  |  | 8 |  |  |
| $\mathrm{l}_{\text {(OFF) }}$ | Power-off output current | B- | $\mathrm{V}_{\mathrm{CC}}=0$, | $0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{O}} \leq 5.25 \mathrm{~V}$ |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{l}_{\text {Oz }}$ | High-impedance output current |  | $\mathrm{V}_{\mathrm{O}}=0$ or $\mathrm{V}_{\mathrm{CC}}$ |  |  | $\pm 1$ | $\mu \mathrm{A}$ |

## SINGLE-ENDED DRIVER SWITCHING CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | $\begin{array}{ccc} \mathrm{MI} & \text { TYP( } \\ \mathbf{N} & \text { 1) } & \\ \text { MAX } \end{array}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {PLH }}$ | Propagation delay time, low-to-high level output | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, See Figure 19 | 2.78 .2 | ns |
| $\mathrm{t}_{\text {PHL }}$ | Propagation delay time, high-to-low level output |  | 2.7 8.2 | ns |
| $\mathrm{tr}_{\mathrm{r}}$ | Differential output signal rise time |  | 0.5 4 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Differential output signal fall time |  | 0.5 4 | ns |
| $\mathrm{t}_{\text {sk(p) }}$ | Pulse skew ( $\left\|t_{\text {PHL }}-t_{\text {PLH }}\right\|$ ) |  | 3.4 | ns |
| $\mathrm{t}_{\text {sk(lim) }}$ | Skew limit ${ }^{(2)}$ |  | 5.5 | ns |
| $t_{\text {en }}$ | Enable time, receiver to driver | See Figure 20 | 50 | ns |
| $t_{\text {PLZ }}$ | Propagation delay time, low-level to high-impedance output |  | 30 | ns |

(1) All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(2) $\mathrm{t}_{\mathrm{sk}(\mathrm{lim})}$ is the maximum delay time difference between any two drivers on any two devices operating at the same supply voltage and the same ambient temperature.

## LVD RECEIVER ELECTRICAL CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN TYP MAX | UNIT |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{1 T_{+}} \quad$ Positive-going differential input voltage threshold | See Figure 21 | 30 | mV |
| $\mathrm{V}_{\text {IT- }} \quad$ Negative-going differential input voltage threshold |  | -30 | mV |
| $\mathrm{V}_{\mathrm{OH}}$ High-level output voltage | $\mathrm{I}_{\mathrm{OH}}=-2 \mathrm{~mA}$ | 3.7 | V |
| $\mathrm{V}_{\text {OL }}$ Low-level output voltage | $\mathrm{l}_{\mathrm{OL}}=2 \mathrm{~mA}$ | 0.5 | V |
| $\mathrm{I}_{1}$ Input current, B+ or B- | $\mathrm{V}_{1}=0 \mathrm{~V}$ to 2.5 V | $\pm 1$ | $\mu \mathrm{A}$ |
| ${ }^{1}$ ) (OFF Power-off Input current, B+ or B- | $\mathrm{V}_{\mathrm{CC}}=0, \quad \mathrm{~V}_{1}=0 \mathrm{~V}$ to 2.5 V | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{H}} \quad$ High-level input current, DE/RE | $\mathrm{V}_{\mathrm{IH}}=3.3 \mathrm{~V}$ ('976), $\mathrm{V}_{\mathrm{IH}}=2 \mathrm{~V}$ ('977) | 50 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }} \quad$ Low-level input current, DE/RE | $\mathrm{V}_{\mathrm{IL}}=1.6 \mathrm{~V}$ ('976), $\quad \mathrm{V}_{\mathrm{IL}}=0.8 \mathrm{~V}$ ('977) | 8 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {Oz }}$ High-impedance output current | $\mathrm{V}_{\mathrm{O}}=0$ or $\mathrm{V}_{\mathrm{CC}}$ | $\pm 30$ | $\mu \mathrm{A}$ |

## LVD RECEIVER SWITCHING CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | $\text { MIN } \begin{array}{lll} \text { TYP( } \\ \text { 1) } \end{array} \text { MAX }$ | UNIT |
| :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {PLH }} \quad$ Propagation delay time, low-to-high level output | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, See Figure 21 | 4.510 | ns |
| $\mathrm{t}_{\text {PHL }} \quad$ Propagation delay time, high-to-low level output |  | 4.510 | ns |
| $\mathrm{t}_{\text {sk(p) }} \quad$ Pulse skew ( $\left\|\mathrm{t}_{\mathrm{PHL}}-\mathrm{t}_{\mathrm{PLH}}\right\|$ ) |  | 3 | ns |
| $\mathrm{t}_{\mathrm{r}} \quad$ Output signal rise time |  | 8 | ns |
| $\mathrm{t}_{\mathrm{f}} \quad$ Output signal fall time |  | 8 | ns |
| $\mathrm{t}_{\text {sk(lim) }}$ Skew limit ${ }^{(2)}$ |  | 5.5 | ns |
| $\mathrm{t}_{\mathrm{PHZ}} \quad$ Propagation delay time, high-level to high-impedance output | See Figure 18 | 42 | ns |
| $\mathrm{t}_{\text {PLZ }} \quad$ Propagation delay time, low-level to high-impedance output |  | 20 | ns |
| $\mathrm{t}_{\mathrm{en}} \quad$ Enable time, driver to receiver |  | 26 | ns |

(1) All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
(2) $\mathrm{t}_{\text {sk(lim) }}$ is the maximum delay time difference between any two drivers on any two devices operating at the same supply voltage and the same ambient temperature.

## SINGLE-ENDED RECEIVER ELECTRICAL CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IT }+}$ | Positive-going input voltage threshold | B- |  |  | 1.6 | 1.9 | V |
| $\mathrm{V}_{\text {IT- }}$ | Negative-going input voltage threshold | B- |  | 1 | 1.1 |  | V |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  | $\mathrm{l}_{\mathrm{OH}}=-2 \mathrm{~mA}$ | 3.7 | 4.6 |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage |  | $\mathrm{I}_{\mathrm{OL}}=2 \mathrm{~mA}$ |  | 0.3 | 0.5 | V |
| I | Input current | B- | $\mathrm{V}_{1}=0$ to $\mathrm{V}_{\mathrm{CC}}$ |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $\begin{aligned} & \mathbf{I}_{\text {(OFF }} \\ & l^{2} \\ & \hline \end{aligned}$ | Power-off Input current | B- | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{I}}=0$ to 5.25 V |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{H}}$ | High-level input current | DE/RE | $\mathrm{V}_{\mathrm{IH}}=3.3 \mathrm{~V}$ ('976), $\mathrm{V}_{\mathrm{IH}}=2 \mathrm{~V}$ ('977) |  |  | 50 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }}$ | Low-level input current | DE/RE | $\mathrm{V}_{\text {IL }}=1.6 \mathrm{~V}$ ('976), $\mathrm{V}_{\text {IL }}=0.8 \mathrm{~V}$ ('977) | 8 |  |  | $\mu \mathrm{A}$ |
| $\mathrm{l}_{\mathrm{Oz}}$ | High-impedance output current |  | $\mathrm{V}_{\mathrm{O}}=0$ or $\mathrm{V}_{\mathrm{CC}}$ |  |  | -30 | $\mu \mathrm{A}$ |

## SINGLE-ENDED RECEIVER SWITCHING CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN | TYP MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {PLH }}$ | Propagation delay time, low-to-high level output | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, See Figure 22 | 7 | 12.5 | ns |
| $\mathrm{t}_{\text {PHL }}$ | Propagation delay time, high-to-low level output |  | 7 | 12.5 | ns |
| $\mathrm{t}_{\text {sk(p) }}$ | Pulse skew (\|t $\mathrm{PHL}^{-} \mathrm{t}_{\text {PLH }} \mid$ ) |  |  | 3.5 | ns |
| $\mathrm{t}_{\mathrm{r}}$ | Output signal rise time |  |  | 8 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Output signal fall time |  |  | 8 | ns |
| $\mathrm{t}_{\text {sk(lim) }}$ | Skew limit ${ }^{(1)}$ |  |  | 5.5 | ns |
| $\mathrm{t}_{\mathrm{PHZ}}$ | Propagation delay time, high-level to high-impedance output | See Figure 20 |  | 20 | ns |
| $\mathrm{t}_{\text {PLZ }}$ | Propagation delay time, low-level to high-impedance output |  |  | 30 | ns |
| ten | Enable time, driver to receiver |  |  | 48 | ns |

[^1]
## PARAMETER MEASUREMENT INFORMATION



Figure 15. Voltage and Current Definitions

A. All input pulses are supplied by a generator having the following characteristics: $t_{r}$ or $t_{f}<1 \mathrm{~ns}$, pulse repetition rate $(P R R)=10 \mathrm{Mpps}$, pulsewidth $=50 \mathrm{~ns} \pm 5 \mathrm{~ns}, \mathrm{Z}_{0}=50 \Omega$.
B. $\quad C_{L}$ includes instrumentation and fixture capacitance within $0,06 \mathrm{~m}$ of the D.U.T.

Figure 16. Differential Output Signal Test Circuit, Timing, and Voltage Definitions

PARAMETER MEASUREMENT INFORMATION (continued)

A. NOTES: . All input pulses are supplied by a generator having the following characteristics: $\mathrm{t}_{\mathrm{r}}$ or $\mathrm{t}_{\mathrm{f}} \leq 1 \mathrm{~ns}$, pulse repetition rate $(P R R)=10 \mathrm{Mpps}$, pulsewidth $=50 \mathrm{~ns} \pm 5 \mathrm{~ns}, \mathrm{Z}_{\mathrm{o}}=50 \Omega$.
B. $\quad C_{L}$ includes instrumentation and fixture capacitance within $0,06 \mathrm{~m}$ of the D.U.T.
C. The measurement of $\mathrm{V}_{\mathrm{OC}(\mathrm{PP})}$ is made on test equipment with a -3 dB bandwidth of at least 300 MHz .

Figure 17. Test Circuit and Definitions for the Driver Common-Mode Output Voltage

## PARAMETER MEASUREMENT INFORMATION (continued)



## VOLTAGE WAVEFORMS

A. All input pulses are supplied by a generator having the following characteristics: $t_{r}$ or $t_{f} \leq 1 \mathrm{~ns}$, pulse repetition rate $(P R R)=1 \mathrm{Mpps}$, pulsewidth $=500 \mathrm{~ns} \pm 50 \mathrm{~ns}, \mathrm{Z}_{\mathrm{o}}=50 \Omega$.
B. $\quad C_{L}$ includes instrumentation and fixture capacitance within $0,06 \mathrm{~m}$ of the D.U.T.

Figure 18. LVD Transceiver Enable and Disable Time Test Circuit and Definitions

PARAMETER MEASUREMENT INFORMATION (continued)

A. All input pulses are supplied by a generator having the following characteristics: $t_{r}$ or $t_{f}<1 \mathrm{~ns}$, pulse repetition rate $(P R R)=10 \mathrm{Mpps}$, pulsewidth $=50 \mathrm{~ns} \pm 5 \mathrm{~ns}, \mathrm{Z}_{\mathrm{o}}=50 \Omega$.
B. $\quad C_{L}$ includes instrumentation and fixture capacitance within $0,06 \mathrm{~m}$ of the D.U.T.

Figure 19. Single-Ended Driver Switching Test Circuit

PARAMETER MEASUREMENT INFORMATION (continued)


Figure 20. Single-Ended Transceiver Enable and Disable Timing Measurements

PARAMETER MEASUREMENT INFORMATION (continued)


VOLTAGE WAVEFORMS
A. All input pulses are supplied by a generator having the following characteristics: $\mathrm{t}_{\mathrm{r}}$ or $\mathrm{t}_{\mathrm{f}} \leq 1 \mathrm{~ns}$, pulse repetition rate $(P R R)=10 \mathrm{Mpps}$, pulsewidth $=50 \mathrm{~ns} \pm 5 \mathrm{~ns}, \mathrm{Z}_{\mathrm{o}}=50 \Omega$.
B. $C_{L}$ includes instrumentation and fixture capacitance within $0,06 \mathrm{~m}$ of the D.U.T.

Figure 21. LVD Receiver Switching Characteristic Test Circuit

## PARAMETER MEASUREMENT INFORMATION (continued)


A. All input pulses are supplied by a generator having the following characteristics: $t_{r}$ or $t_{f}<1 \mathrm{~ns}$, pulse repetition rate $(P R R)=10 \mathrm{Mpps}$, pulsewidth $=50 \mathrm{~ns} \pm 5 \mathrm{~ns}$.
B. $\quad C_{L}$ includes instrumentation and fixture capacitance within $0,06 \mathrm{~m}$ of the D.U.T.

Figure 22. Single-Ended Receiver Timing Test Circuit

## APPLICATION INFORMATION



Figure 23. Low-Pass Filter for Connecting DIFFSENS to CDEO

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing |  | Package Qty | $\text { Eco Plan }{ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN75LVDM976DGG | ACTIVE | TSSOP | DGG | 56 | 35 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM976DGGG4 | ACTIVE | TSSOP | DGG | 56 | 35 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM976DGGR | ACTIVE | TSSOP | DGG | 56 | 2000 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br})$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM976DGGRG4 | ACTIVE | TSSOP | DGG | 56 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM976DL | ACTIVE | SSOP | DL | 56 | 20 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM976DLG4 | ACTIVE | SSOP | DL | 56 | 20 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM976DLR | ACTIVE | SSOP | DL | 56 | 1000 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM976DLRG4 | ACTIVE | SSOP | DL | 56 | 1000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM977DGG | ACTIVE | TSSOP | DGG | 56 | 35 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM977DGGG4 | ACTIVE | TSSOP | DGG | 56 | 35 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \\ \hline \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM977DGGR | ACTIVE | TSSOP | DGG | 56 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM977DGGRG4 | ACTIVE | TSSOP | DGG | 56 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM977DL | ACTIVE | SSOP | DL | 56 | 20 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM977DLG4 | ACTIVE | SSOP | DL | 56 | 20 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM977DLR | ACTIVE | SSOP | DL | 56 | 1000 | Green (RoHS \& no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| SN75LVDM977DLRG4 | ACTIVE | SSOP | DL | 56 | 1000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-2-260C-1 YEAR |

${ }^{(1)}$ The marketing status values are defined as follows:
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${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
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${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> $\mathbf{W 1}(\mathbf{m m})$ | $\mathbf{A 0}(\mathbf{m m})$ | B0 $(\mathbf{m m})$ | K0 $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | $\mathbf{W}$ <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN75LVDM976DGGR | TSSOP | DGG | 56 | 2000 | 330.0 | 24.4 | 8.6 | 15.6 | 1.8 | 12.0 | 24.0 | Q1 |
| SN75LVDM976DLR | SSOP | DL | 56 | 1000 | 330.0 | 32.4 | 11.35 | 18.67 | 3.1 | 16.0 | 32.0 | Q1 |
| SN75LVDM977DGGR | TSSOP | DGG | 56 | 2000 | 330.0 | 24.4 | 8.6 | 15.6 | 1.8 | 12.0 | 24.0 | Q1 |
| SN75LVDM977DLR | SSOP | DL | 56 | 1000 | 330.0 | 32.4 | 11.35 | 18.67 | 3.1 | 16.0 | 32.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN75LVDM976DGGR | TSSOP | DGG | 56 | 2000 | 346.0 | 346.0 | 41.0 |
| SN75LVDM976DLR | SSOP | DL | 56 | 1000 | 346.0 | 346.0 | 49.0 |
| SN75LVDM977DGGR | TSSOP | DGG | 56 | 2000 | 346.0 | 346.0 | 41.0 |
| SN75LVDM977DLR | SSOP | DL | 56 | 1000 | 346.0 | 346.0 | 49.0 |

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    (2) All voltage values are with respect to GND unless otherwise noted.

[^1]:    (1) $t_{\mathrm{sk}(\mathrm{lim})}$ is the maximum delay time difference between any two drivers on any two devices operating at the same supply voltage and the same ambient temperature.

